

Dual P-channel MOSFET

ELM14821AA-N

■ General description

ELM14821AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 1.8V and internal ESD protection.

■ Features

- $V_{ds} = -12V$
- $I_d = -8A$ ($V_{gs} = -4.5V$)
- $R_{ds(on)} < 18m\Omega$ ($V_{gs} = -4.5V$)
- $R_{ds(on)} < 22m\Omega$ ($V_{gs} = -2.5V$)
- $R_{ds(on)} < 29m\Omega$ ($V_{gs} = -1.8V$)
- ESD Rating : 4000V HBM

■ Maximum absolute ratings

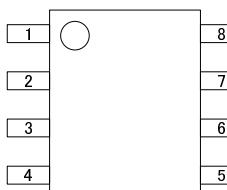
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-12	V	
Gate-source voltage	V_{gs}	± 8	V	
Continuous drain current Ta=25°C	I_d	-8.0	A	1
Ta=70°C		-6.7		
Pulsed drain current	I_{dm}	-20	A	2
Power dissipation Ta=25°C	P_d	2.00	W	1
Ta=70°C		1.28		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	48.0	62.5	°C/W	1
Maximum junction-to-ambient		74.0	110.0	°C/W	
Maximum junction-to-lead	$R_{\theta jl}$	35.0	40.0	°C/W	3

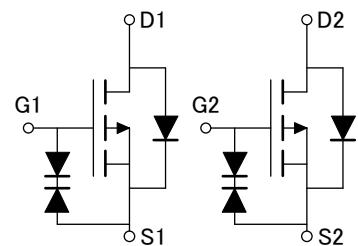
■ Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE2
2	GATE2
3	SOURCE1
4	GATE1
5	DRAIN1
6	DRAIN1
7	DRAIN2
8	DRAIN2

■ Circuit



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■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BV_{dss}	$I_d=-250 \mu A, V_{gs}=0V$	-12			V
Zero gate voltage drain current	Id_{ss}	$V_{ds}=-9.6V$ $V_{gs}=0V$			-1 -5	μA
			$T_j=55^\circ C$			
Gate-body leakage current	I_{gss}	$V_{ds}=0V, V_{gs}=\pm 4.5V$ $V_{ds}=0V, V_{gs}=\pm 8V$			± 1 ± 10	μA
Gate threshold voltage	$V_{gs(th)}$	$V_{ds}=V_{gs}, I_d=-250 \mu A$	-0.30	-0.55	-1.00	V
On state drain current	$I_{d(on)}$	$V_{gs}=-4.5V, V_{ds}=-5V$	-20			A
Static drain-source on-resistance	$R_{ds(on)}$	$V_{gs}=-4.5V$		14.8	18.0	$m\Omega$
		$I_d=-8A$	$T_j=125^\circ C$	19.0	23.0	
		$V_{gs}=-2.5V, I_d=-8A$		18.3	22.0	
		$V_{gs}=-1.8V, I_d=-5A$		22.4	29.0	
Forward transconductance	G_{fs}	$V_{ds}=-5V, I_d=-8A$		34		S
Diode forward voltage	V_{sd}	$I_s=-1A, V_{gs}=0V$		-0.74	-1.00	V
Max. body-diode continuous current	I_s				-2.5	A
DYNAMIC PARAMETERS						
Input capacitance	C_{iss}	$V_{gs}=0V, V_{ds}=-6V, f=1MHz$		3960		pF
Output capacitance	C_{oss}			910		pF
Reverse transfer capacitance	C_{rss}			757		pF
Gate resistance	R_g	$V_{gs}=0V, V_{ds}=0V, f=1MHz$		6.9		Ω
SWITCHING PARAMETERS						
Total gate charge	Q_g	$V_{gs}=-4.5V, V_{ds}=-6V$ $I_d=-8A$		37.0		nC
Gate-source charge	Q_{gs}			4.4		nC
Gate-drain charge	Q_{gd}			11.0		nC
Turn-on delay time	$t_{d(on)}$	$V_{gs}=-4.5V, V_{ds}=-6V$ $R_l=0.75 \Omega, R_{gen}=3 \Omega$		15		ns
Turn-on rise time	t_r			43		ns
Turn-off delay time	$t_{d(off)}$			158		ns
Turn-off fall time	t_f			95		ns
Body diode reverse recovery time	t_{rr}	$I_f=-8A, dI/dt=100A/\mu s$		63		ns
Body diode reverse recovery charge	Q_{rr}	$I_f=-8A, dI/dt=100A/\mu s$		56		nC

NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

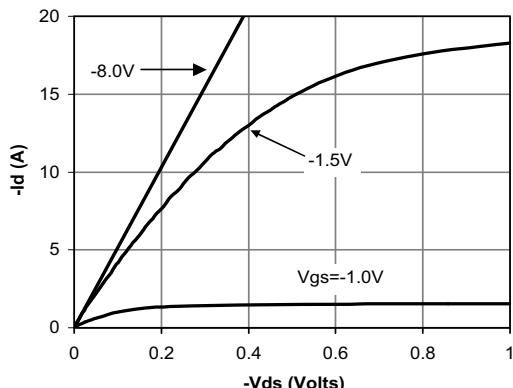


Fig 1: On-Region Characteristics

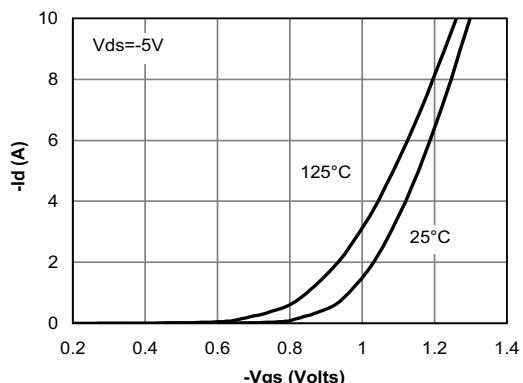


Figure 2: Transfer Characteristics

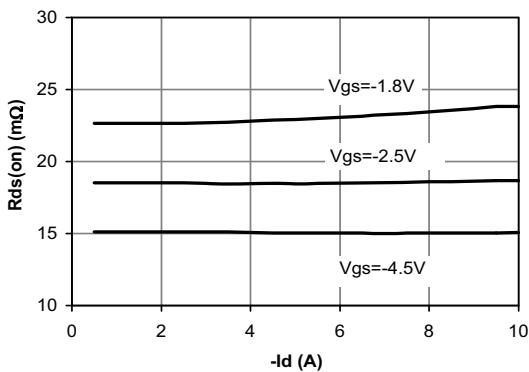


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

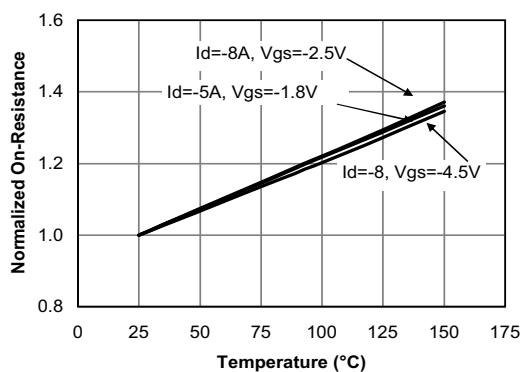


Figure 4: On-Resistance vs. Junction Temperature

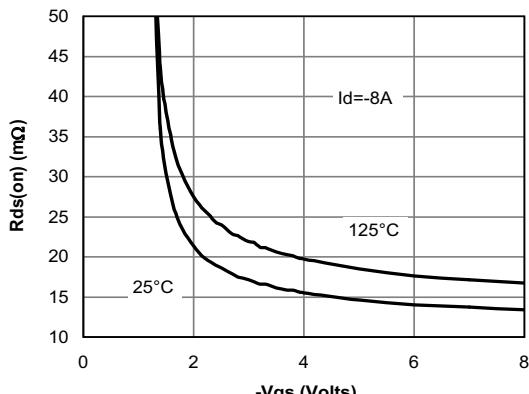


Figure 5: On-Resistance vs. Gate-Source Voltage

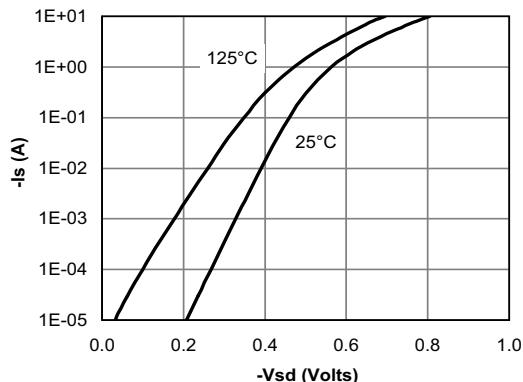


Figure 6: Body-Diode Characteristics

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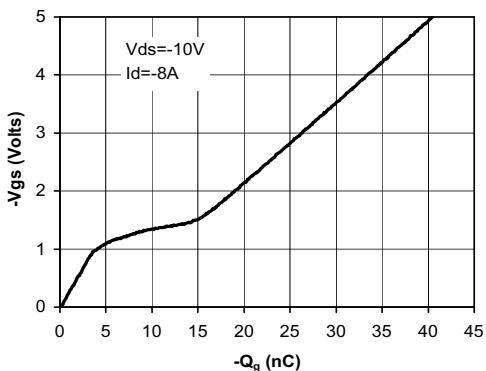


Figure 7: Gate-Charge Characteristics

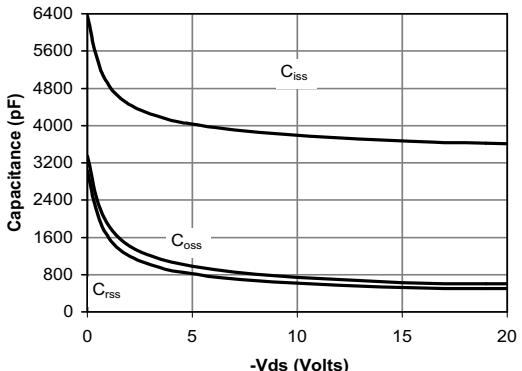


Figure 8: Capacitance Characteristics

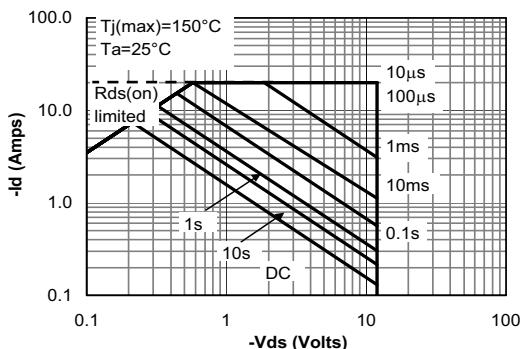


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

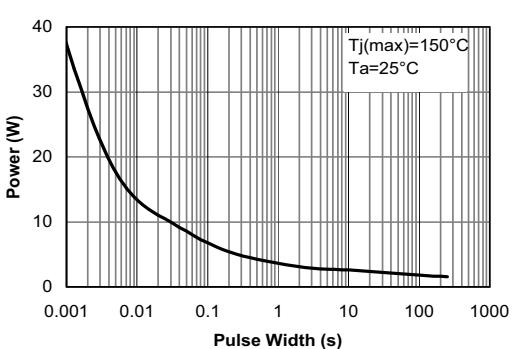


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

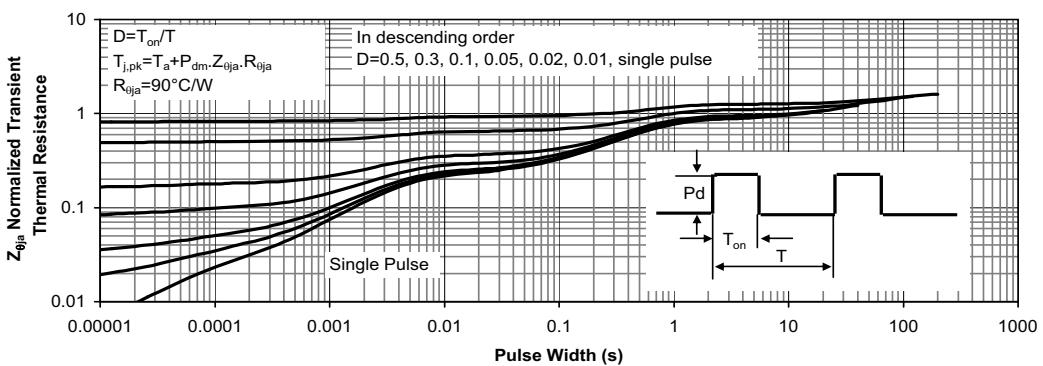


Figure 11: Normalized Maximum Transient Thermal Impedance